

## General Description

The GreenMOS<sup>®</sup> high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS<sup>®</sup> S series is optimized for its switching characteristics to achieve aggressive EMI standards. It is easy to use for smaller power supply systems to meet the both efficiency and EMI standards.

## Features

- Low  $R_{DS(ON)}$  & FOM
- Extremely low switching loss
- Excellent stability and uniformity




## Applications

- LED lighting
- Charger
- Adapter
- Telecom power
- Server power
- Solar/UPS

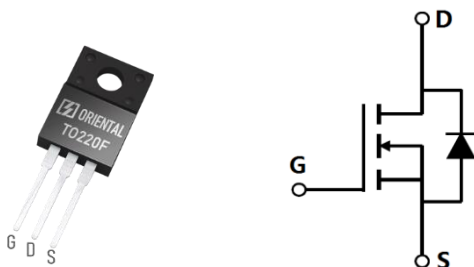
## Key Performance Parameters

Parameter	Value	Unit
$V_{DS, min} @ T_{j(max)}$	650	V
$I_{D, pulse}$	60	A
$R_{DS(ON), max} @ V_{GS}=10V$	200	
$Q_g$	72.9	nC

## Marking Information

Product Name	Package	Marking
OSG60R200FSZF	TO220F	OSG60R200FSZ

## Package & Pin Information



Enhancement Mode N-

### Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	$C_{iss}$		1920		pF	$V_{GS}=0\text{ V}$ , $V_{DS}=50\text{ V}$ , - 100 kHz
Output capacitance	$C_{oss}$		98.6		pF	
Reverse transfer capacitance	$C_{rss}$		2.3		pF	
Turn-on delay time	$t_{d(on)}$		41.9		ns	$V_{GS}=10\text{ V}$ , $V_{DS}=400\text{ V}$ , $R_G=2$ $I_D=10\text{ A}$
Rise time	$t_r$		68.2		ns	
Turn-off delay time	$t_{d(off)}$		77.7		ns	
Fall time	$t_f$		33.9		ns	

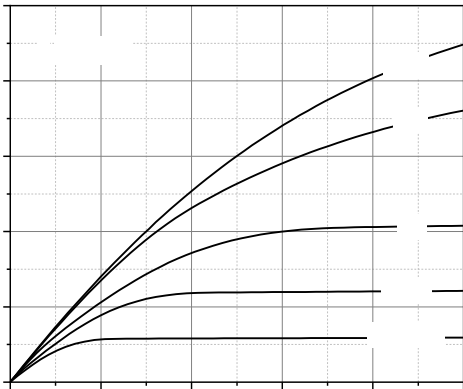
### Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	$Q_g$		72.9		nC	$V_{GS}=10\text{ V}$ , $V_{DS}=400\text{ V}$ , $I_D=10\text{ A}$
Gate-source charge	$Q_{gs}$		17.2		nC	
Gate-drain charge	$Q_{gd}$		14		nC	
Gate plateau voltage	$V_{plateau}$		6.5		V	

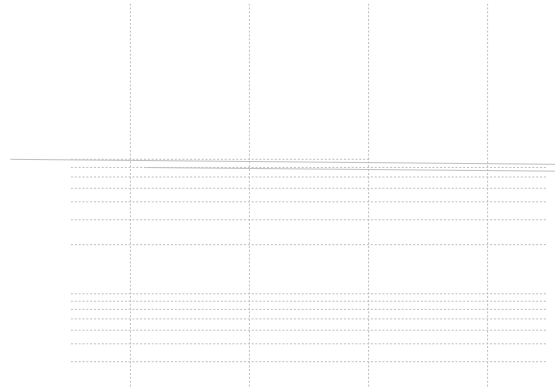
### Body Diode Characteristics

Parameter	Symbol	Test condition
Diode forward voltage	$V_{SD}$	

**Electrical Characteristics Diagrams**



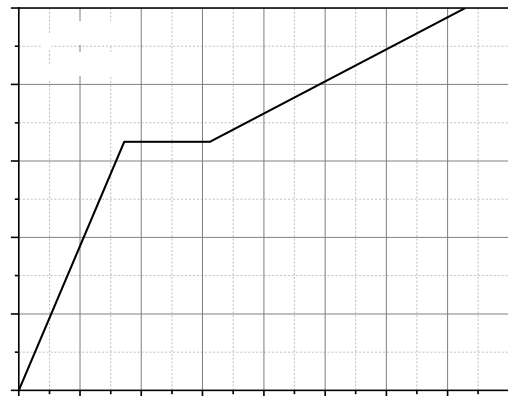
**Figure 1. Typ. output characteristics**



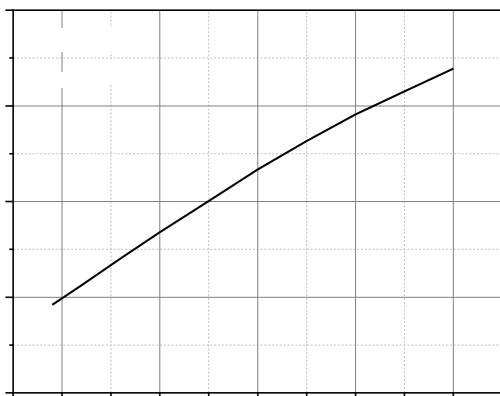
**Figure 2. Typ. transfer characteristics**



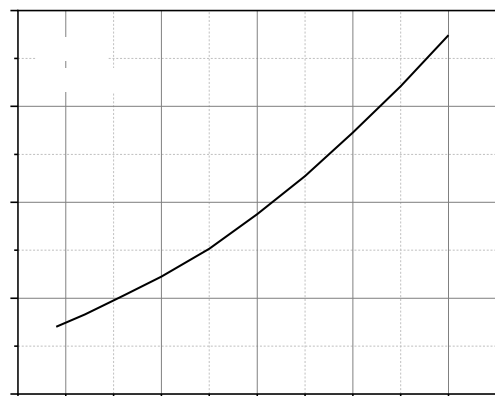
**Figure 3. Typ. capacitances**



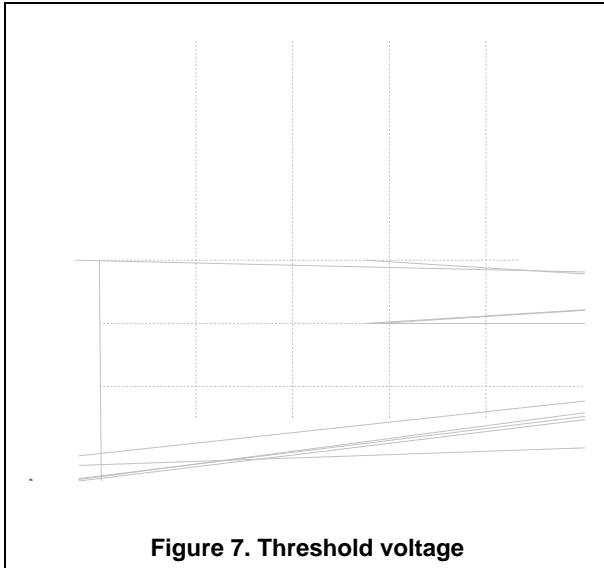
**Figure 4. Typ. gate charge**



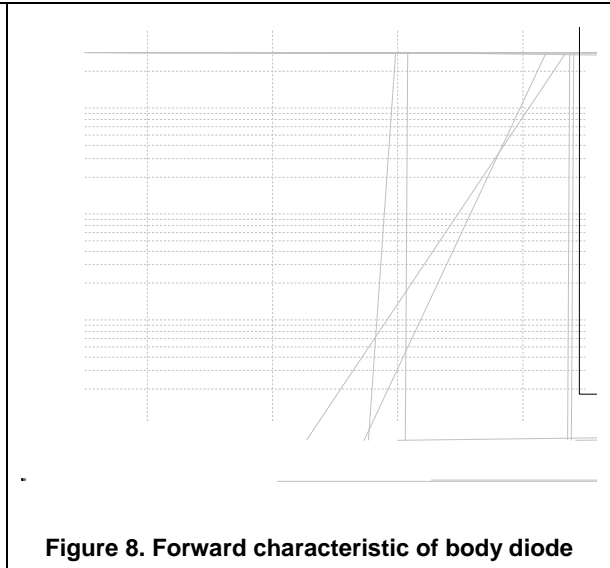
**Figure 5. Drain-source breakdown voltage**



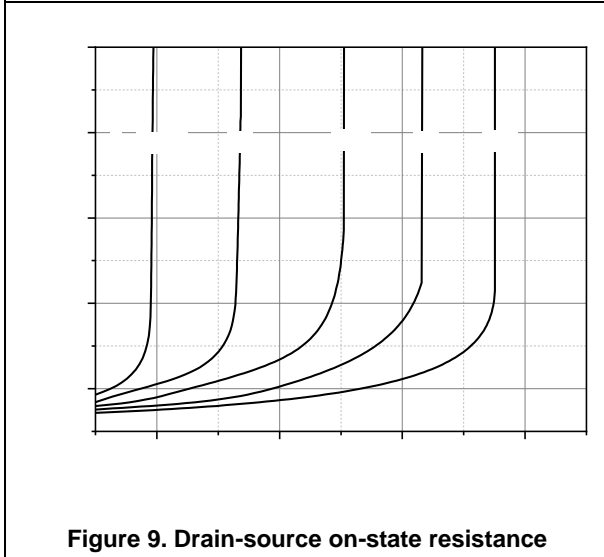
**Figure 6. Drain-source on-state resistance**



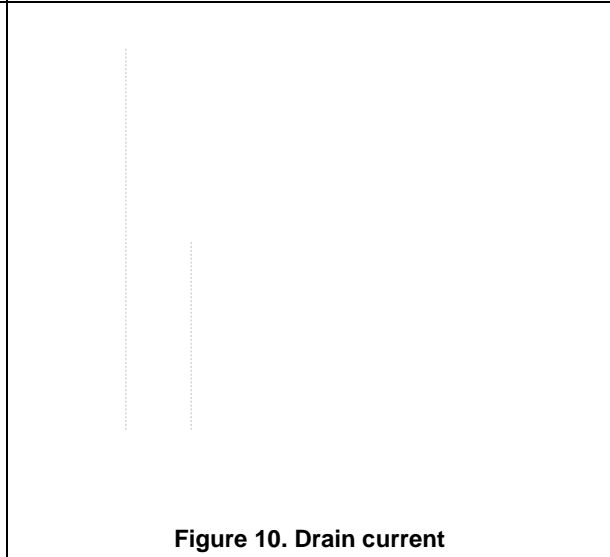
**Figure 7. Threshold voltage**



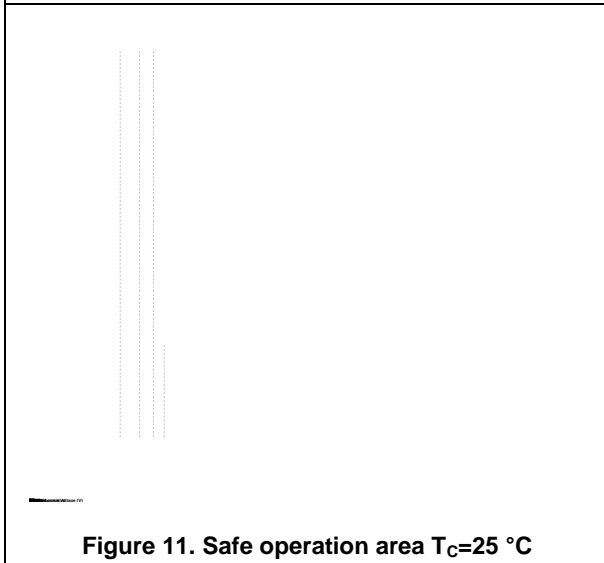
**Figure 8. Forward characteristic of body diode**



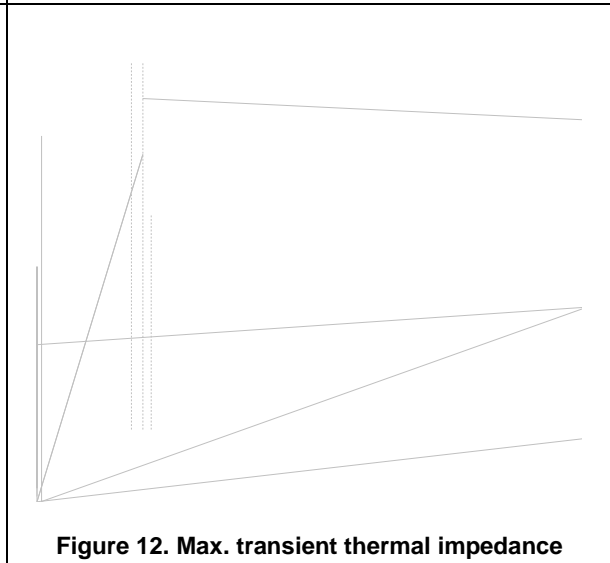
**Figure 9. Drain-source on-state resistance**



**Figure 10. Drain current**



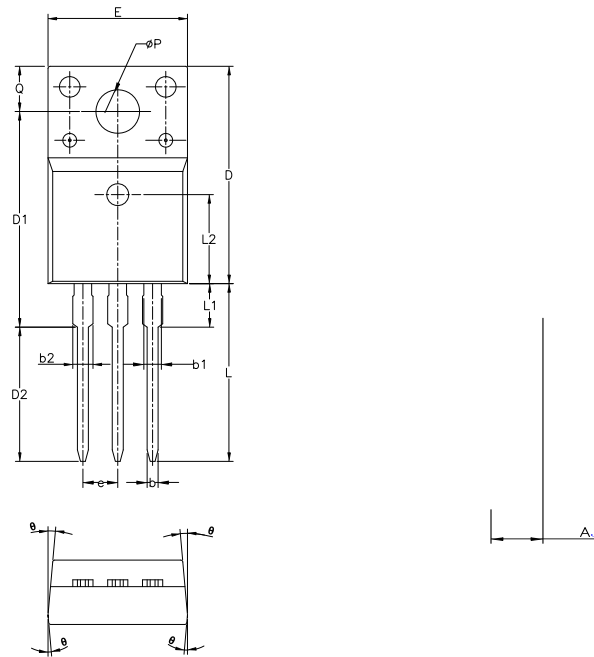
**Figure 11. Safe operation area  $T_C=25^\circ\text{C}$**



**Figure 12. Max. transient thermal impedance**



**Package Information**



Symbol	mm		
	Min	Nom	Max
A	4.50	4.70	4.83
A1	2.34	2.54	2.74
A2	0.70 REF		
A3	2.56	2.76	2.93
b	0.70	-	0.90
b1	1.18	-	1.38
b2	-	-	1.47
c	0.45	0.50	0.60
D	15.67	15.87	16.07
D1	15.55	15.75	15.95
D2	9.60	9.80	10.00
E	9.96	10.16	10.36
e	2.54 BSC		
H1	6.48	6.68	6.88
L	12.68	12.98	13.28
L1	-	-	3.50
L2	6.50 REF		
	3.08	3.18	3.28
Q	3.20	-	3.40
	1°	3°	5°

Version 1: TO220F-J package outline dimension

**Ordering Information**

Package Type	Units/ Tube	Tubes/ Inner Box	Units/ Inner Box	Inner Boxes/ Carton Box	Units/ Carton Box
TO220F-J	50	20	1000	5	5000

**Product Information**

Product	Package	Pb Free	RoHS	Halogen Free
OSG60R200FSZF	TO220F	yes	yes	yes

**Legal Disclaimer**